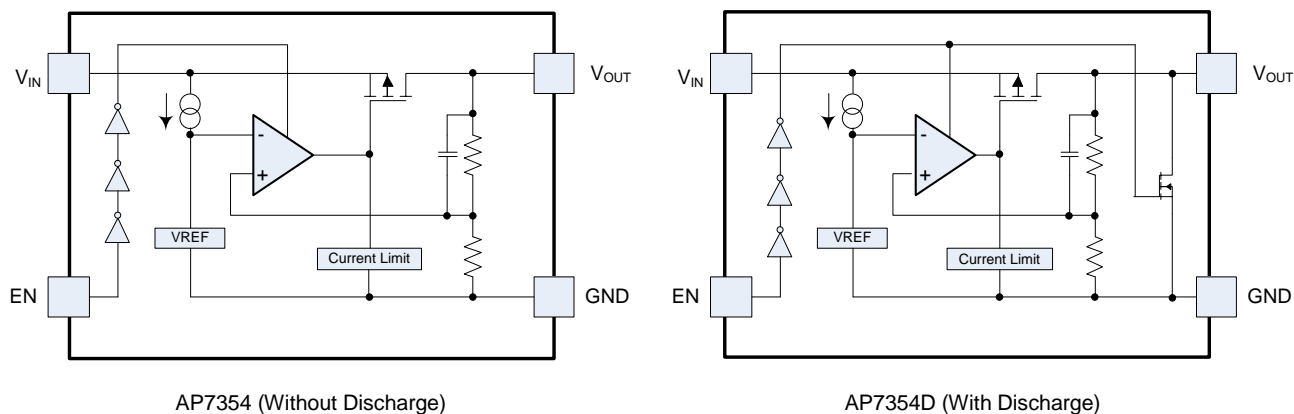


## Pin Description

Pin Number			Pin Name	Function
SOT25	SOT23	X2-DFN1010-4 (Type B)		
3	—	3	EN	Chip Enable — This should be driven either high or low and must not be floating. Driving EN high enables regulator output, while pulling it low places regulator into shutdown mode.
2	3	2	GND	Ground
5	2	1	V <sub>OUT</sub>	Output Voltage
1	1	4	V <sub>IN</sub>	Power Input
—	—	Center Pad	—	No connection or ground. Note: Chip Ground must be through GND pin.

## Functional Block Diagram



EN Pin Not Available on SOT23

## Absolute Maximum Ratings (Note 5)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	4	kV
ESD MM	Machine Model ESD Protection	400	V
V <sub>IN</sub>	Input Voltage	6.0	V
V <sub>EN</sub>	Input Voltage at EN Pin	6.0	V
V <sub>OUT</sub>	Output Voltage to GND	-0.3 to V <sub>IN</sub> +0.3	V
T <sub>A</sub>	Operating Ambient Temperature	-40 to +85	°C
T <sub>J</sub>	Maximum Junction Temperature	+125	°C
T <sub>STG</sub>	Storage Temperature	-55 to +125	°C
P <sub>D</sub>	Power Dissipation (Note 6)	315	mW

Notes:

- Stresses beyond those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods can affect device reliability.
- This is based on an application temperature of +40°C. Derate 3.75mW per °C for each degree above +40°C.

## Recommended Operating Conditions

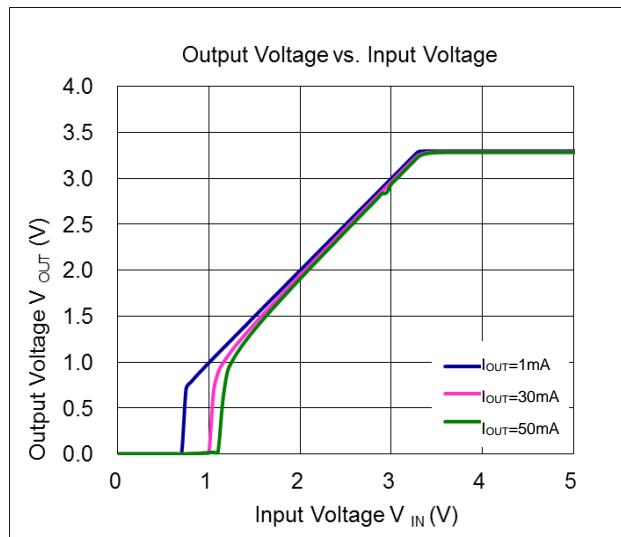
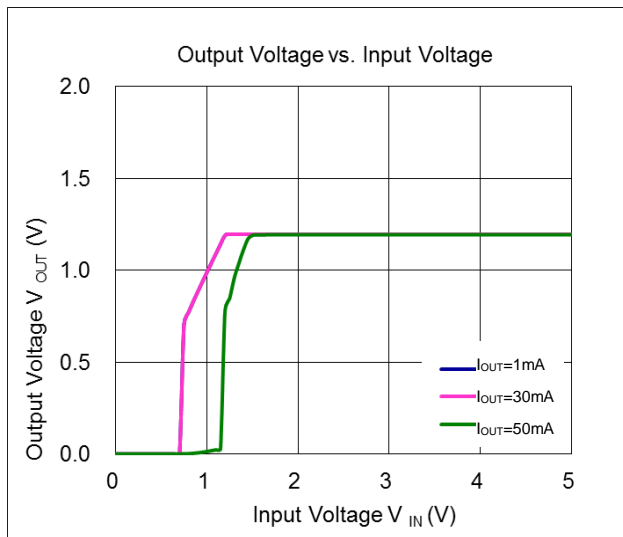
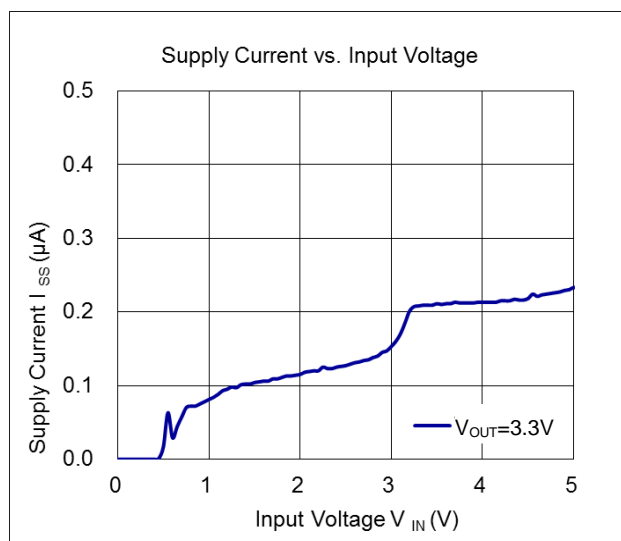
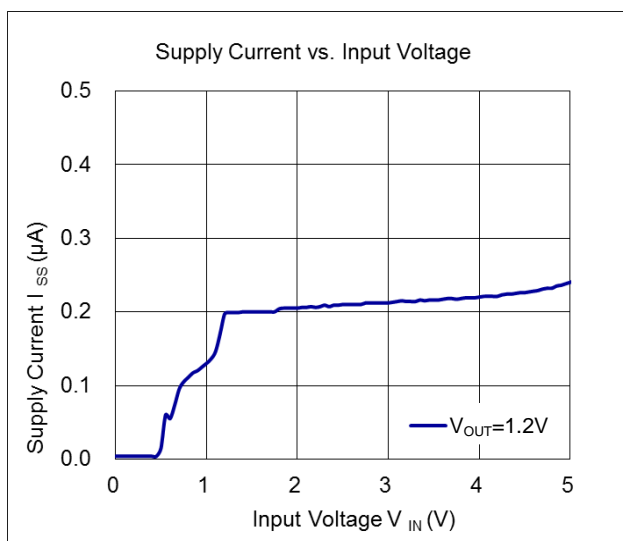
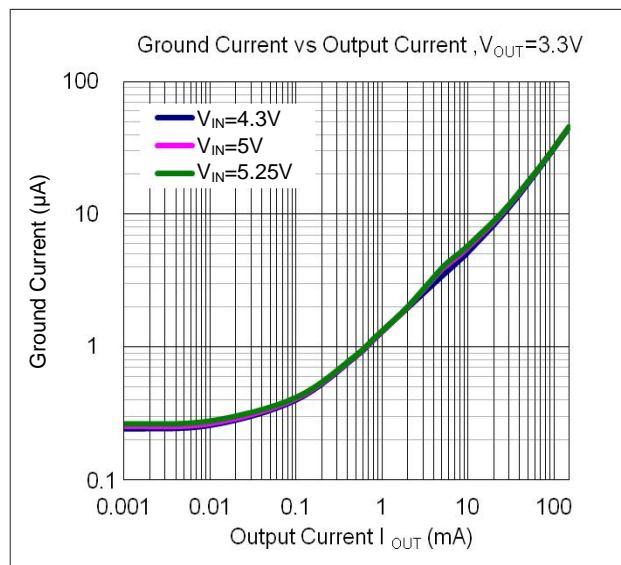
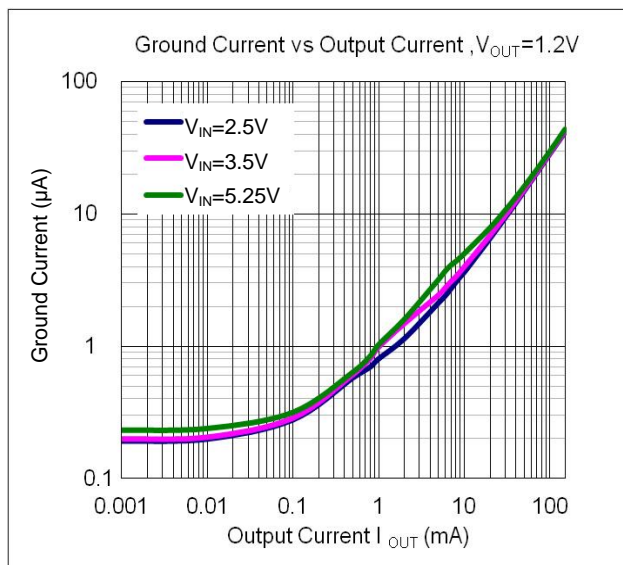
Symbol	Parameter	Min	Max	Unit
V <sub>IN</sub>	Input Voltage	2.0	5.5	V
I <sub>OUT</sub>	Output Current	0	150	mA
T <sub>A</sub>	Operating Ambient Temperature	-40	+85	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, V<sub>EN</sub> = V<sub>IN</sub> = V<sub>OUT</sub>+1V (1.5V < V<sub>OUT</sub> ≤ 4.5V), V<sub>EN</sub> = V<sub>IN</sub> = 2.5V (V<sub>OUT</sub> ≤ 1.5V), I<sub>OUT</sub> = 1mA, C<sub>IN</sub> = C<sub>OUT</sub> = 0.1μF, unless otherwise specified.)

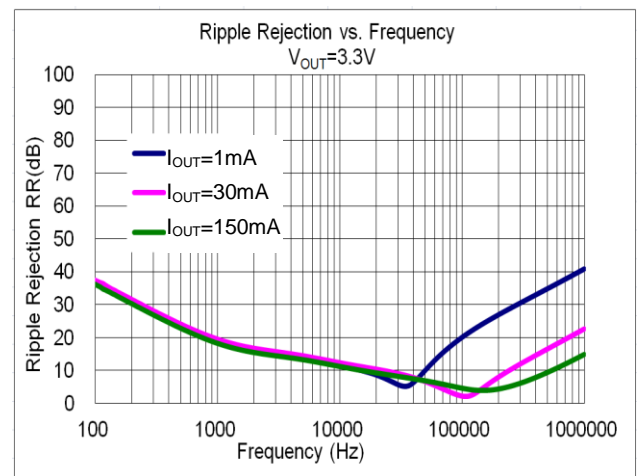
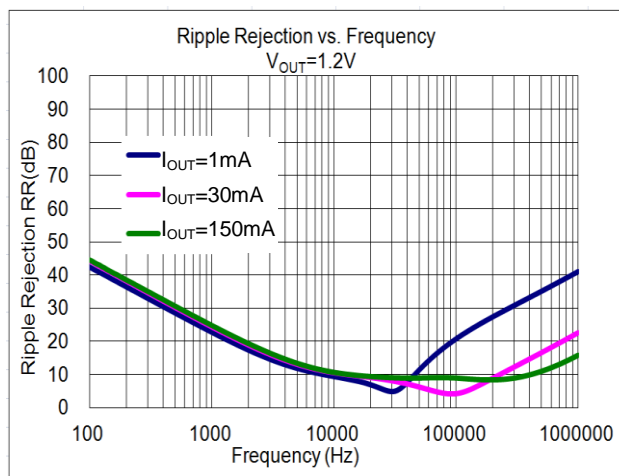
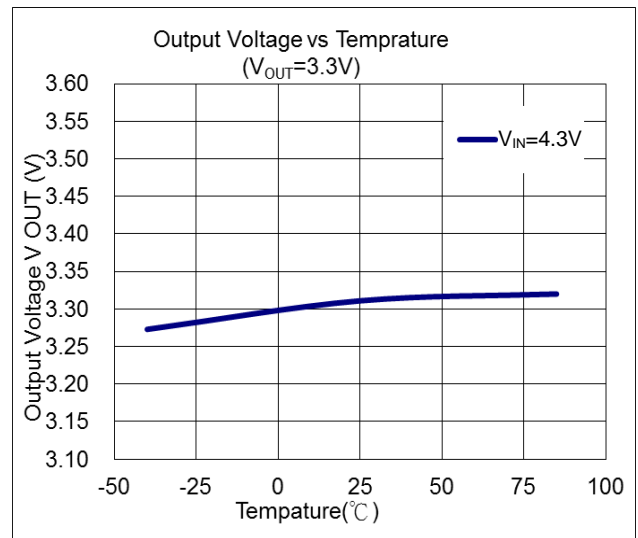
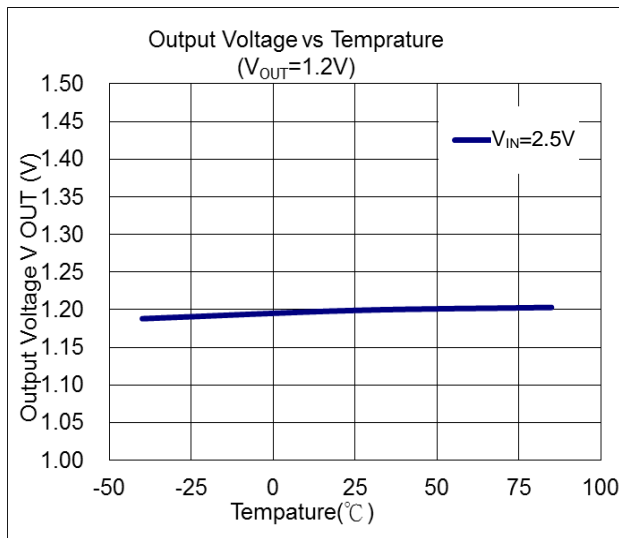
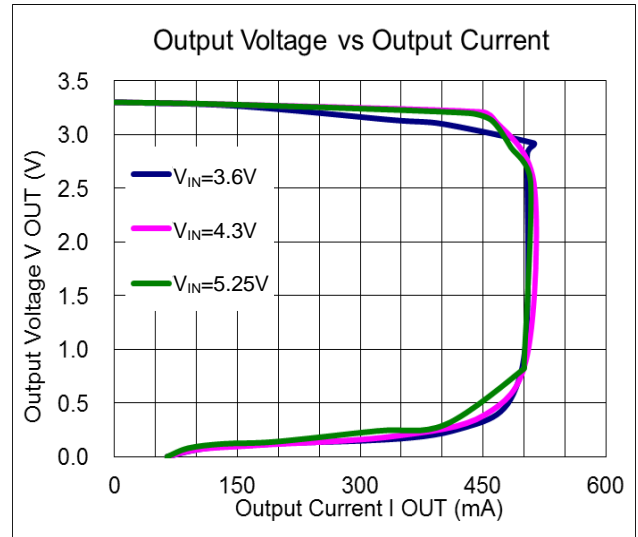
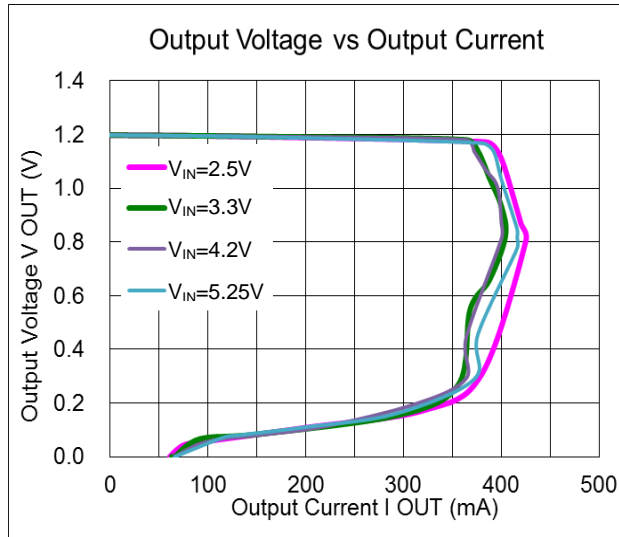
Parameter	Conditions		Min	Typ	Max	Unit
Input Voltage	T <sub>A</sub> = -40°C to +85°C		2.0	—	5.5	V
Output Voltage Accuracy	V <sub>OUT</sub> > 2.0V I <sub>OUT</sub> = 1mA	T <sub>A</sub> = +25°C	-1	—	+1	%
		T <sub>A</sub> = -40°C to +85°C	-2	—	+2	
	V <sub>OUT</sub> ≤ 2.0V I <sub>OUT</sub> = 1mA	T <sub>A</sub> = +25°C	-40	—	40	mV
		T <sub>A</sub> = -40°C to +85°C	-80	—	80	
Line Regulation (ΔV <sub>OUT</sub> /ΔV <sub>IN</sub> /V <sub>OUT</sub> )	MAX (V <sub>OUT</sub> + 1.0V, 2.5V) ≤ V <sub>IN</sub> ≤ 5.5V (All Versions Except 4.5V)		—	0.02	0.1	%/V
Load Regulation (ΔV <sub>OUT</sub> )	1mA ≤ I <sub>OUT</sub> ≤ 150mA (All Versions Except 4.5V)		-40	—	40	mV
	1mA ≤ I <sub>OUT</sub> ≤ 150mA (Applicable to 4.5V Version)		-55	—	55	mV
Short Circuit Current Limit (Note 7)	V <sub>OUT</sub> = 0V		—	60	—	mA
Quiescent Current (Note 8)	I <sub>OUT</sub> = 0mA		—	0.25	0.6	μA
I <sub>STANDBY</sub>	Set EN Low, No Load		—	0.02	0.2	μA
Output Current	—		150	—	—	mA
Dropout Voltage (Note 9)	I <sub>OUT</sub> = 150mA	V <sub>OUT</sub> = 1.1V	—	0.70	1.00	V
		V <sub>OUT</sub> = 1.2V	—	0.60	0.90	
		V <sub>OUT</sub> = 1.5V	—	0.43	0.75	
		V <sub>OUT</sub> = 1.8V	—	0.33	0.60	
		V <sub>OUT</sub> = 1.85V	—	0.32	0.58	
		V <sub>OUT</sub> = 2.2V	—	0.27	0.52	
		V <sub>OUT</sub> = 2.5V	—	0.22	0.48	
		V <sub>OUT</sub> = 2.8V	—	0.19	0.40	
		V <sub>OUT</sub> = 3.0V	—	0.18	0.35	
		V <sub>OUT</sub> = 3.3V	—	0.16	0.35	
		V <sub>OUT</sub> = 4.5V	—	0.14	0.35	
EN Input Low Voltage	—		—	—	0.4	V
EN Input High Voltage	—		1.0	—	5.5	V
Active Output Discharge Resistance (Note 10)	V <sub>IN</sub> = 4.0V, V <sub>EN</sub> = 0V		—	35	—	Ω
Θ <sub>JA</sub> Thermal Resistance Junction-to-Ambient	(Note 11)	SOT23	—	170	—	°C/W
		SOT25	—	162	—	
		X2-DFN1010-4 (Type B)	—	295	—	
Θ <sub>JC</sub> Thermal Resistance Junction-to-Case	(Note 11)	SOT23	—	43	—	°C/W
		SOT25	—	38	—	
		X2-DFN1010-4 (Type B)	—	120	—	

- Notes:
- Short-circuit current is measured with V<sub>OUT</sub> pulled to GND.
  - Quiescent current defined as the difference in current between the input and the output.
  - Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.
  - AP7354 is available with two options: built-in discharge (AP7354D) and non-discharge (AP7354).
  - Test condition: Device mounted on 1" x 1" FR-4 MRP substrate PCB, 2oz copper, with minimum recommended pad layout.

## Performance Characteristics

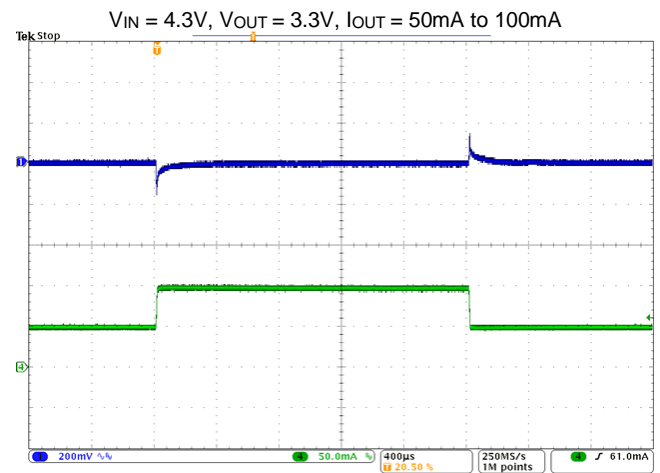
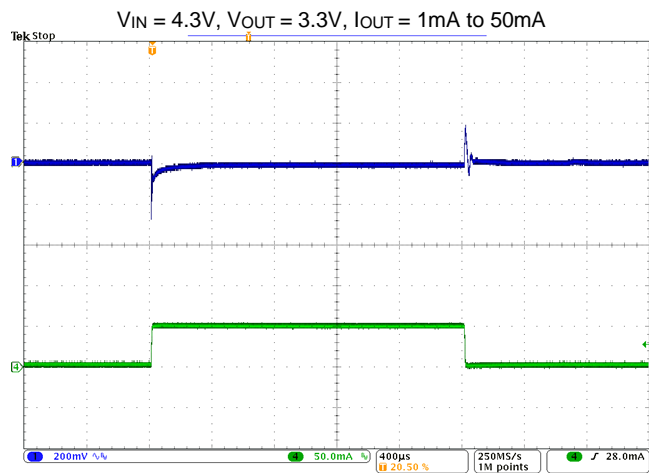
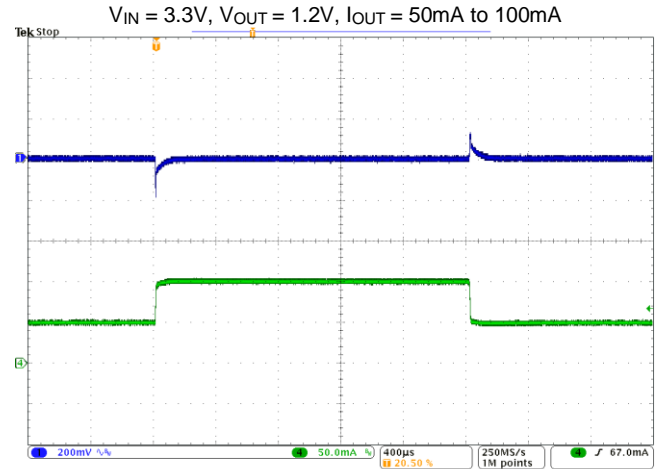
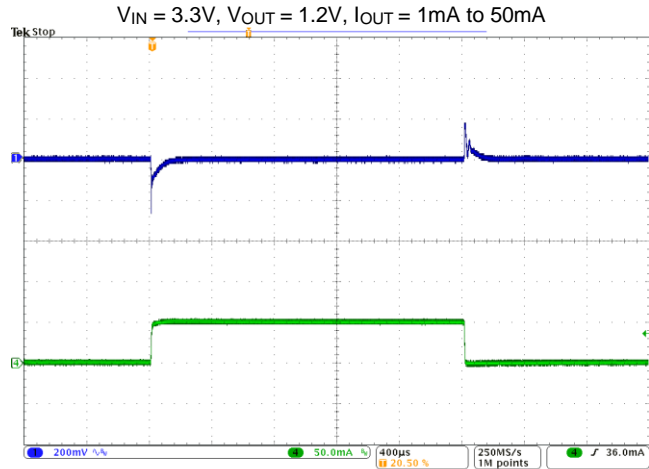


**Performance Characteristics** (continued)



## Performance Characteristics (continued)

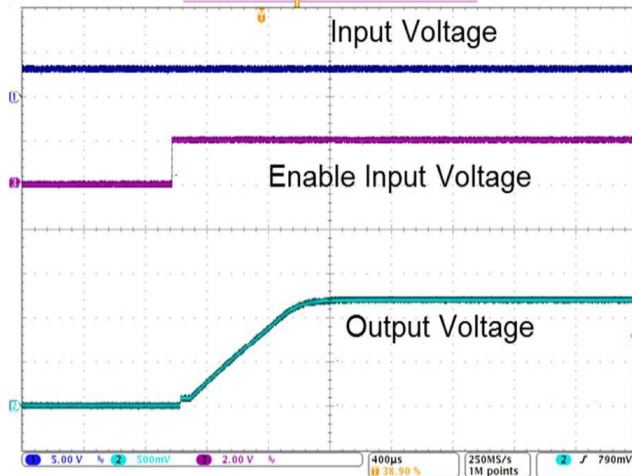
Load Transient Response ( $C_{IN} = C_{OUT} = 0.1\mu F$ ,  $t_r = t_f = 5.0\mu s$ , unless otherwise specified.)



**Performance Characteristics** (continued)

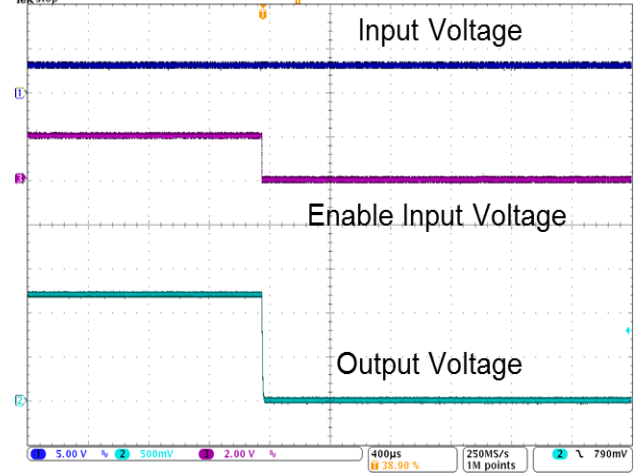
**TURN ON**

$V_{IN} = 3.3V$ ,  $V_{OUT} = 1.2V$ ,  $I_{OUT} = 0mA$ ,  $C_{IN} = C_{OUT} = 0.1\mu F$

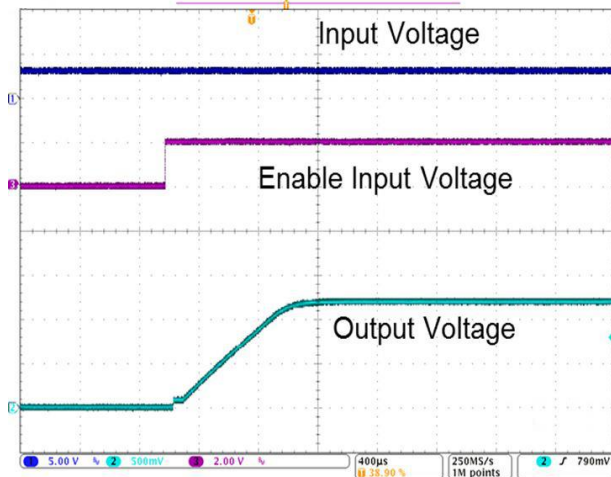


**TURN OFF**

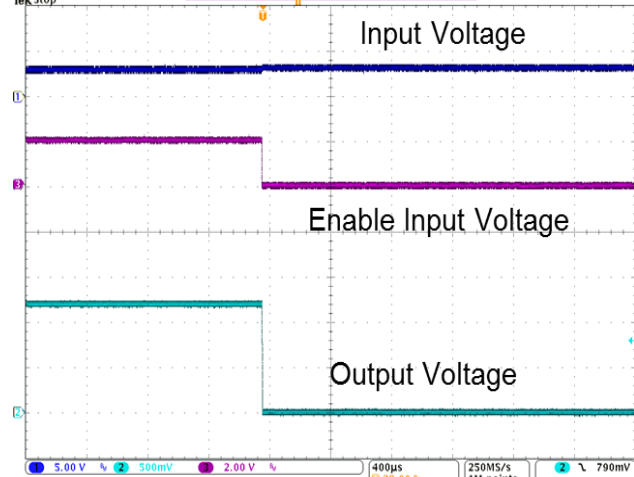
$V_{IN} = 3.3V$ ,  $V_{OUT} = 1.2V$ ,  $I_{OUT} = 0mA$ ,  $C_{IN} = C_{OUT} = 0.1\mu F$



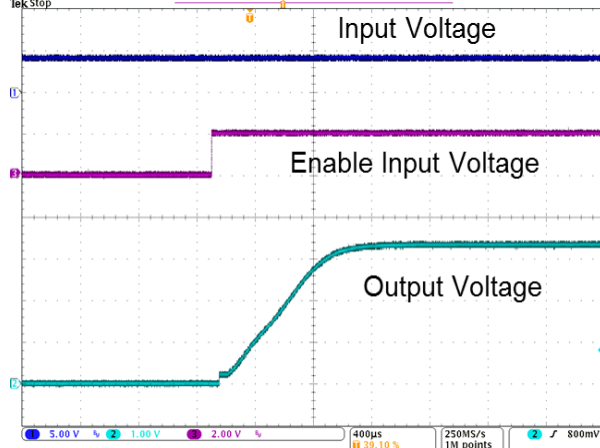
$V_{IN} = 3.3V$ ,  $V_{OUT} = 1.2V$ ,  $I_{OUT} = 150mA$ ,  $C_{IN} = C_{OUT} = 0.1\mu F$



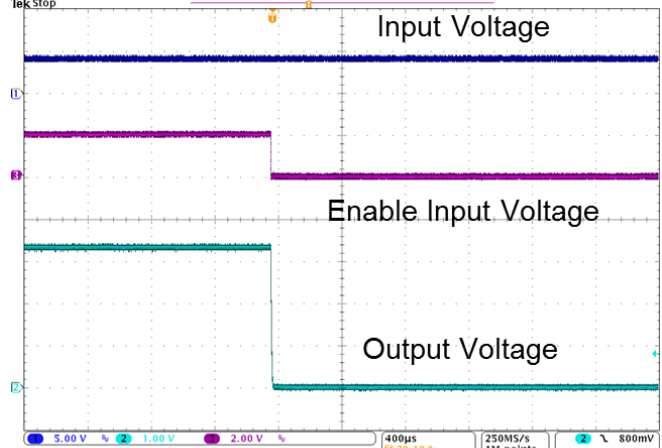
$V_{IN} = 3.3V$ ,  $V_{OUT} = 1.2V$ ,  $I_{OUT} = 150mA$ ,  $C_{IN} = C_{OUT} = 0.1\mu F$



$V_{IN} = 4.3V$ ,  $V_{OUT} = 3.3V$ ,  $I_{OUT} = 0mA$ ,  $C_{IN} = C_{OUT} = 0.1\mu F$

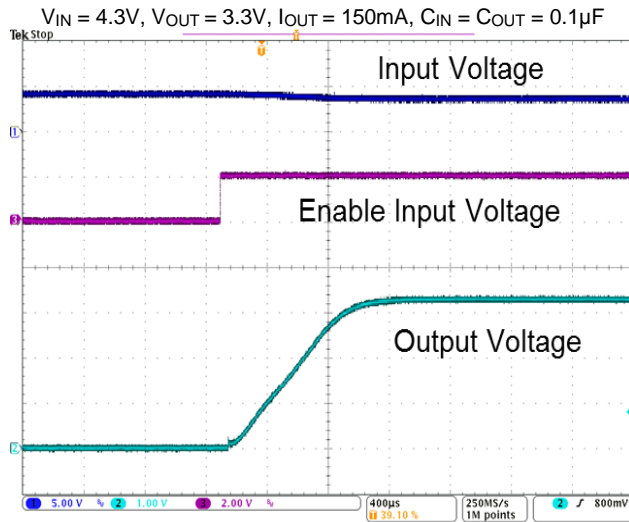


$V_{IN} = 4.3V$ ,  $V_{OUT} = 3.3V$ ,  $I_{OUT} = 0mA$ ,  $C_{IN} = C_{OUT} = 0.1\mu F$

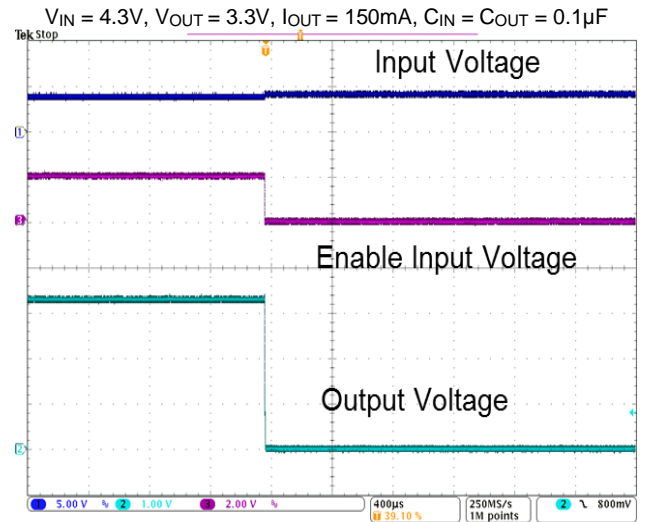


## Performance Characteristics (continued)

TURN ON



TURN OFF



## Application Information

### Output Capacitor

An output capacitor ( $C_{OUT}$ ) is required to improve transient response and maintain stability. The AP7354 is stable with very small ceramic output capacitors. The equivalent series resistance (ESR) and capacitance drive the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the GND pin. Care must be taken to reduce the impedance in the layout.

### Input Capacitor

To prevent the input voltage from dropping during load steps, it is recommended to utilize an input capacitor ( $C_{IN}$ ). A minimum 0.1 $\mu$ F ceramic capacitor is recommended between  $V_{IN}$  and GND pin to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both  $V_{IN}$  and GND pin.

### Enable Control

The AP7354 is turned on by setting the EN pin high, and is turned off by pulling them low. If this feature is not used, the EN pin should be tied to  $V_{IN}$  pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pin must be able to swing above and below the specified turn-on/off voltage thresholds listed in the *Electrical Characteristics* section.

### Layout Considerations

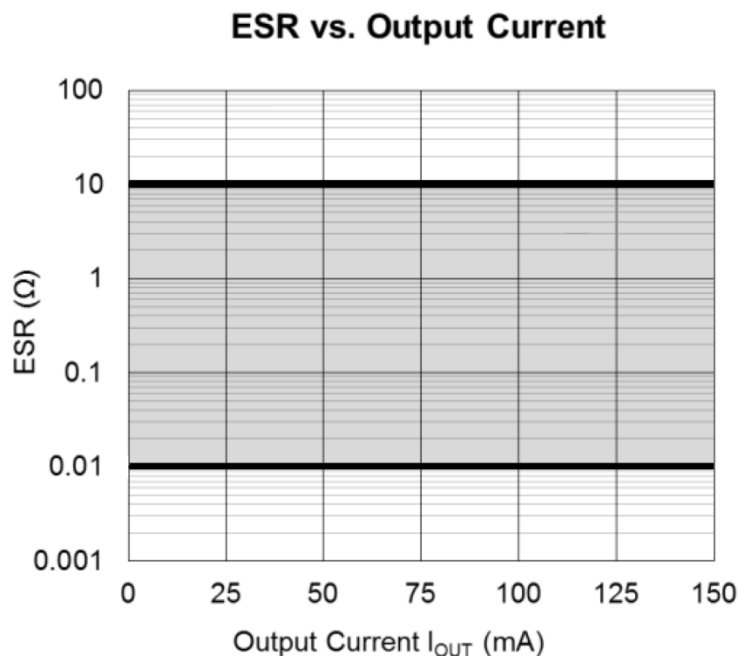
For good ground loop and stability, the input and output capacitors must be located close to the input, output, and GND pin of the device. The regulator GND pin must be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace must be used for large current paths from  $V_{IN}$  to  $V_{OUT}$  and load circuit.

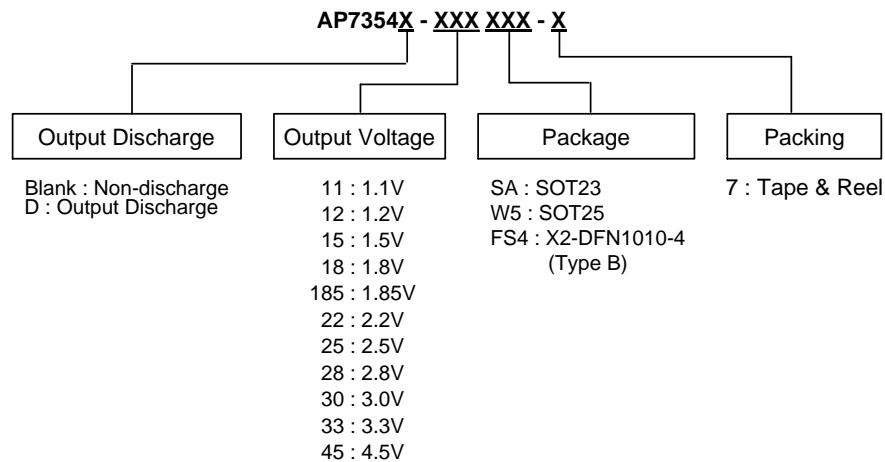
## ESR vs. Output Current

A ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR also can be used. The relations between  $I_{OUT}$  (output current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph.

Measurement Conditions:

- Frequency Band: 10Hz to 2MHz
- Temperature: -40°C to +85°C



**Ordering Information** (Note 12)


Output Voltage	SOT23	SOT25 Without Discharge	SOT25 With Discharge	7" Tape and Reel	
				Quantity	Part Number Suffix
1.2	AP7354-12SA-7	AP7354-12W5-7	AP7354D-12W5-7	3000/Tape & Reel	-7
1.5	AP7354-15SA-7	AP7354-15W5-7	AP7354D-15W5-7	3000/Tape & Reel	-7
1.8	AP7354-18SA-7	AP7354-18W5-7	AP7354D-18W5-7	3000/Tape & Reel	-7
1.85	AP7354-185SA-7	AP7354-185W5-7	AP7354D-185W5-7	3000/Tape & Reel	-7
2.2	AP7354-22SA-7	—	—	3000/Tape & Reel	-7
2.5	AP7354-25SA-7	AP7354-25W5-7	AP7354D-25W5-7	3000/Tape & Reel	-7
2.8	AP7354-28SA-7	AP7354-28W5-7	AP7354D-28W5-7	3000/Tape & Reel	-7
3.0	AP7354-30SA-7	AP7354-30W5-7	AP7354D-30W5-7	3000/Tape & Reel	-7
3.3	AP7354-33SA-7	AP7354-33W5-7	AP7354D-33W5-7	3000/Tape & Reel	-7
4.5	AP7354-45SA-7	AP7354-45W5-7	AP7354D-45W5-7	3000/Tape & Reel	-7

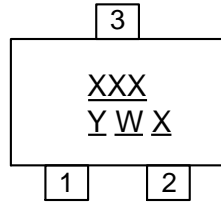
Output Voltage	X2-DFN1010-4 (Type B) Without Discharge	X2-DFN1010-4 (Type B) With Discharge	7" Tape and Reel	
			Quantity	Part Number Suffix
1.1	AP7354-11FS4-7	AP7354D-11FS4-7	5000/Tape & Reel	-7
1.2	AP7354-12FS4-7	AP7354D-12FS4-7	5000/Tape & Reel	-7
1.5	AP7354-15FS4-7	AP7354D-15FS4-7	5000/Tape & Reel	-7
1.8	AP7354-18FS4-7	AP7354D-18FS4-7	5000/Tape & Reel	-7
1.85	AP7354-185FS4-7	AP7354D-185FS4-7	5000/Tape & Reel	-7
2.5	AP7354-25FS4-7	AP7354D-25FS4-7	5000/Tape & Reel	-7
2.8	AP7354-28FS4-7	AP7354D-28FS4-7	5000/Tape & Reel	-7
3.0	AP7354-30FS4-7	AP7354D-30FS4-7	5000/Tape & Reel	-7
3.3	AP7354-33FS4-7	AP7354D-33FS4-7	5000/Tape & Reel	-7
4.5	AP7354-45FS4-7	AP7354D-45FS4-7	5000/Tape & Reel	-7

Note: 12. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information

(1) SOT23

(Top View)



XXX : Identification Code

Y : Year 0 to 9

W : Week : A to Z : 1 to 26 week;  
a to z : 27 to 52 week; z represents  
52 and 53 week

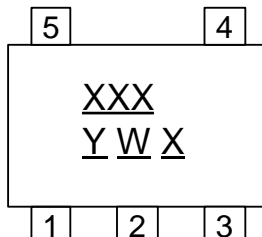
X : Internal Code

Part Number	Package	Identification Code
AP7354-12SA-7	SOT23	A8A
AP7354-15SA-7	SOT23	A8B
AP7354-18SA-7	SOT23	A8C
AP7354-185SA-7	SOT23	A8D
AP7354-22SA-7	SOT23	A8K
AP7354-25SA-7	SOT23	A8E
AP7354-28SA-7	SOT23	A8F
AP7354-30SA-7	SOT23	A8G
AP7354-33SA-7	SOT23	A8H
AP7354-45SA-7	SOT23	A8J

## Marking Information (continued)

(2) SOT25

(Top View)



XXX : Identification Code

Y : Year 0 to 9

W : Week : A to Z : 1 to 26 week;  
a to z : 27 to 52 week; z represents  
52 and 53 week

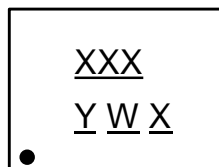
X : Internal Code

Part Number	Package	Identification Code
AP7354-12W5-7	SOT25	A8A
AP7354-15W5-7	SOT25	A8B
AP7354-18W5-7	SOT25	A8C
AP7354-185W5-7	SOT25	A8D
AP7354-25W5-7	SOT25	A8E
AP7354-28W5-7	SOT25	A8F
AP7354-30W5-7	SOT25	A8G
AP7354-33W5-7	SOT25	A8H
AP7354-45W5-7	SOT25	A8J
AP7354D-12W5-7	SOT25	A9A
AP7354D-15W5-7	SOT25	A9B
AP7354D-18W5-7	SOT25	A9C
AP7354D-185W5-7	SOT25	A9D
AP7354D-25W5-7	SOT25	A9E
AP7354D-28W5-7	SOT25	A9F
AP7354D-30W5-7	SOT25	A9G
AP7354D-33W5-7	SOT25	A9H
AP7354D-45W5-7	SOT25	A9J

## Marking Information (continued)

### (3) X2-DFN1010-4 (Type B)

(Top View)



XXX : Identification Code

Y : Year : 0~9

W : Week : A~Z : 1~26 week;

a~z : 27~52 week; z represents  
52 and 53 week

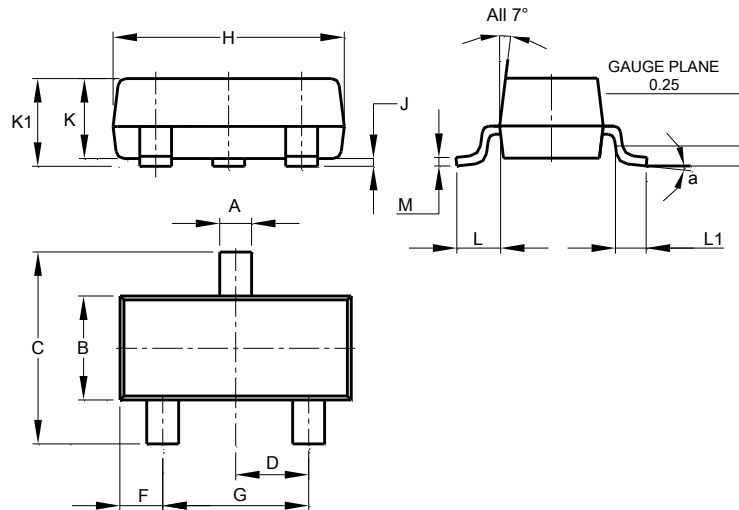
X : Internal Code

Part Number	V <sub>OUT</sub>	Package	Identification Code
AP7354-11FS4-7	1.1V	X2-DFN1010-4 (Type B)	A8M
AP7354-12FS4-7	1.2V	X2-DFN1010-4 (Type B)	A8A
AP7354-15FS4-7	1.5V	X2-DFN1010-4 (Type B)	A8B
AP7354-18FS4-7	1.8V	X2-DFN1010-4 (Type B)	A8C
AP7354-185FS4-7	1.85V	X2-DFN1010-4 (Type B)	A8D
AP7354-25FS4-7	2.5V	X2-DFN1010-4 (Type B)	A8E
AP7354-28FS4-7	2.8V	X2-DFN1010-4 (Type B)	A8F
AP7354-30FS4-7	3.0V	X2-DFN1010-4 (Type B)	A8G
AP7354-33FS4-7	3.3V	X2-DFN1010-4 (Type B)	A8H
AP7354-45FS4-7	4.5V	X2-DFN1010-4 (Type B)	A8J
AP7354D-11FS4-7	1.1V	X2-DFN1010-4 (Type B)	A9M
AP7354D-12FS4-7	1.2V	X2-DFN1010-4 (Type B)	A9A
AP7354D-15FS4-7	1.5V	X2-DFN1010-4 (Type B)	A9B
AP7354D-18FS4-7	1.8V	X2-DFN1010-4 (Type B)	A9C
AP7354D-185FS4-7	1.85V	X2-DFN1010-4 (Type B)	A9D
AP7354D-25FS4-7	2.5V	X2-DFN1010-4 (Type B)	A9E
AP7354D-28FS4-7	2.8V	X2-DFN1010-4 (Type B)	A9F
AP7354D-30FS4-7	3.0V	X2-DFN1010-4 (Type B)	A9G
AP7354D-33FS4-7	3.3V	X2-DFN1010-4 (Type B)	A9H
AP7354D-45FS4-7	4.5V	X2-DFN1010-4 (Type B)	A9J

## Package Outline Dimensions

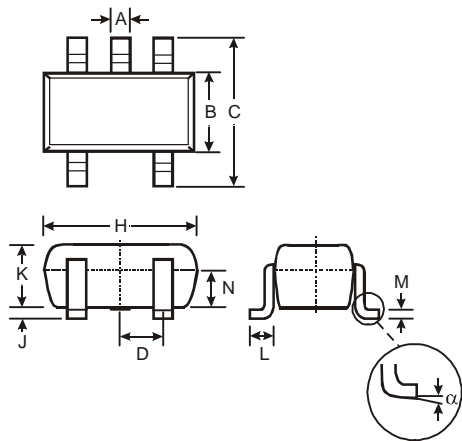
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (1) Package Type: SOT23



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

### (2) Package Type: SOT25

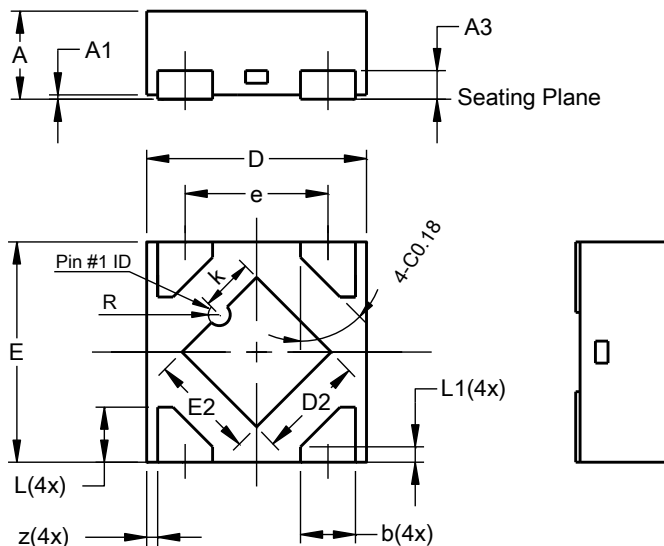


SOT25			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	-	-	0.95
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
N	0.70	0.80	0.75
α	0°	8°	-
All Dimensions in mm			

## Package Outline Dimensions (continued)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (3) Package Type: X2-DFN1010-4 (Type B)

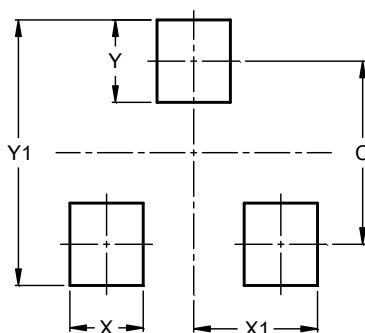


X2-DFN1010-4 (Type B)			
Dim	Min	Max	Typ
A	-	0.40	0.39
A1	0.00	0.05	0.02
A3	-	-	0.13
b	0.20	0.30	0.25
D	0.95	1.05	1.00
D2	0.43	0.53	0.48
E	0.95	1.05	1.00
E2	0.43	0.53	0.48
e	-	-	0.65
k	0.19	0.29	0.24
L	0.20	0.30	0.25
L1	0.02	0.12	0.07
R	0.02	0.08	0.05
z	-	-	0.050
All Dimensions in mm			

## Suggested Pad Layout

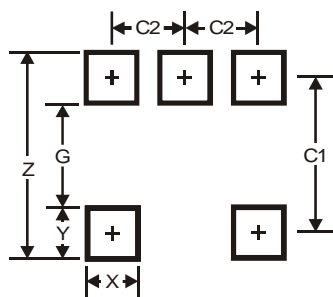
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (1) Package Type: SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

### (2) Package Type: SOT25

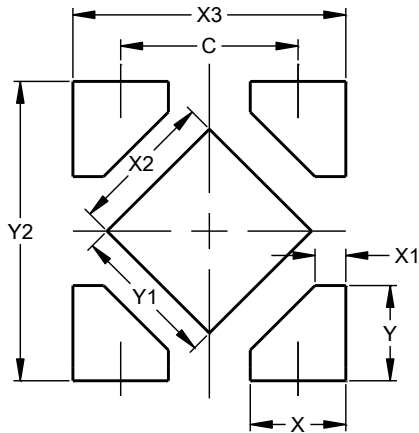


Dimensions	Value
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95

## Suggested Pad Layout (continued)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (3) Package Type: X2-DFN1010-4 (Type B)



Dimensions	Value (in mm)
C	0.650
X	0.350
X1	0.112
X2	0.530
X3	1.00
Y	0.350
Y1	0.530
Y2	1.100

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